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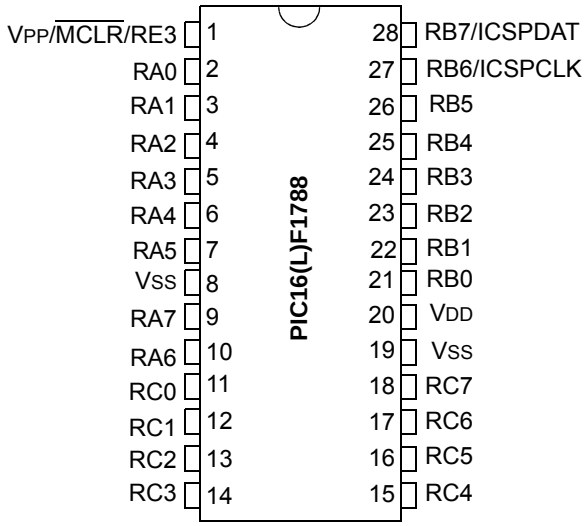
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PSMC, PWM, WDT
Number of I/O	24
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 11x12b; D/A 1x8b, 3x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1788t-i-ss

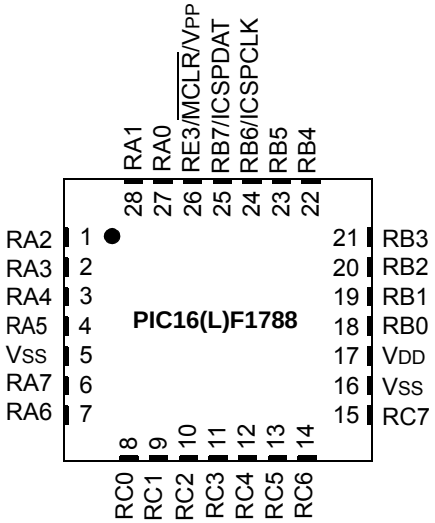
Pin Diagram – 28-Pin SPDIP, SOIC, SSOP



Note: See Table 1 for the location of all peripheral functions.

Pin Diagram – 28-Pin QFN

QFN



Note: See Table 1 for the location of all peripheral functions.

TABLE 1-3: PIC16(L)F1789 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RB4/AN11/C3IN1+/$\overline{SS}$(1)	RB4	TTL/ST	CMOS	General purpose I/O.
	AN11	AN	—	ADC Channel 11 input.
	C3IN1+	AN	—	Comparator C3 positive input.
	$\overline{SS}$	ST	—	Slave Select input.
RB5/AN13/C4IN2-/T1G/CCP3(1) SDO(1)	RB5	TTL/ST	CMOS	General purpose I/O.
	AN13	AN	—	ADC Channel 13 input.
	C4IN2-	AN	—	Comparator C4 negative input.
	T1G	ST	—	Timer1 gate input.
	CCP3	ST	CMOS	Capture/Compare/PWM3.
	SDO	—	CMOS	SPI data output.
RB6/C4IN1+/TX(1)/CK(1)/SDI(1)/ SDA(1)/ICSPCLK	RB6	TTL/ST	CMOS	General purpose I/O.
	C4IN1+	AN	—	Comparator C4 positive input.
	TX	—	CMOS	EUSART asynchronous transmit.
	CK	ST	CMOS	EUSART synchronous clock.
	SDI	ST	—	SPI data input.
	SDA	I^2C	OD	I^2C data input/output.
	ICSPCLK	ST	—	Serial Programming Clock.
RB7/DAC1OUT2/DAC2OUT2/ DAC3OUT2/DAC4OUT2/RX(1)/ DT(1)/SCK(1)/SCL(1)/ICSPDAT	RB7	TTL/ST	CMOS	General purpose I/O.
	DAC1OUT2	—	AN	Voltage Reference output.
	DAC2OUT2	—	AN	Voltage Reference output.
	DAC3OUT2	—	AN	Voltage Reference output.
	DAC4OUT2	—	AN	Voltage Reference output.
	RX	ST	—	EUSART asynchronous input.
	DT	ST	CMOS	EUSART synchronous data.
	SCK	ST	CMOS	SPI clock.
	SCL	I^2C	OD	I^2C clock.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
RC0/T1OSO/T1CKI/PSMC1A	RC0	TTL/ST	CMOS	General purpose I/O.
	T1OSO	XTAL	XTAL	Timer1 Oscillator Connection.
	T1CKI	ST	—	Timer1 clock input.
	PSMC1A	—	CMOS	PSMC1 output A.
RC1/T1OSI/PSMC1B/CCP2	RC1	TTL/ST	CMOS	General purpose I/O.
	T1OSI	XTAL	XTAL	Timer1 Oscillator Connection.
	PSMC1B	—	CMOS	PSMC1 output B.
	CCP2	ST	CMOS	Capture/Compare/PWM2.
RC2/PSMC1C/CCP1	RC2	TTL/ST	CMOS	General purpose I/O.
	PSMC1C	—	CMOS	PSMC1 output C.
	CCP1	ST	CMOS	Capture/Compare/PWM1.
RC3/PSMC1D/SCK/SCL	RC3	TTL/ST	CMOS	General purpose I/O.
	PSMC1D	—	CMOS	PSMC1 output D.
	SCK	ST	CMOS	SPI clock.
	SCL	I^2C	OD	I^2C clock.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2C levels
HV = High Voltage XTAL = Crystal

Note 1: Pin functions can be assigned to one of two locations via software. See **Register 13-1**.
2: All pins have interrupt-on-change functionality.

EXAMPLE 3-2: ACCESSING PROGRAM MEMORY VIA FSR

```
constants
    DW      DATA0   ;First constant
    DW      DATA1   ;Second constant
    DW      DATA2
    DW      DATA3
my_function
    ;… LOTS OF CODE…
    MOVLW   DATA_INDEX
    ADDLW   LOW constants
    MOVWF   FSR1L
    MOVLW   HIGH constants ;MSb is set
automatically
    MOVWF   FSR1H
    BTFSC   STATUS,C    ;carry from ADDLW?
    INCF    FSR1H,f     ;yes
    MOVIW   0[FSR1]
;THE PROGRAM MEMORY IS IN W
```

3.2.1.1 STATUS Register

The STATUS register, shown in Register 3-1, contains:

- the arithmetic status of the ALU
- the Reset status

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the $\overline{TO}$ and $\overline{PD}$ bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper three bits and set the Z bit. This leaves the STATUS register as '`000u u1uu`' (where u = unchanged).

It is recommended, therefore, that only `BCF`, `BSF`, `SWAPF` and `MOVWF` instructions are used to alter the STATUS register, because these instructions do not affect any Status bits. For other instructions not affecting any Status bits (Refer to **Section 30.0 "Instruction Set Summary"**).

Note:	The C and DC bits operate as $\overline{\text{Borrow}}$ and $\overline{\text{Digit Borrow}}$ out bits, respectively, in subtraction.

3.3 Register Definitions: Status

REGISTER 3-1: STATUS: STATUS REGISTER

U-0	U-0	U-0	R-1/q	R-1/q	R/W-0/u	R/W-0/u	R/W-0/u
—	—	—	$\overline{TO}$	$\overline{PD}$	Z	DC(1)	C(1)
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **$\overline{TO}$:** Time-Out bit
- 1 = After power-up, `CLRWDT` instruction or `SLEEP` instruction
- 0 = A WDT time-out occurred

bit 3 **$\overline{PD}$:** Power-Down bit
- 1 = After power-up or by the `CLRWDT` instruction
- 0 = By execution of the `SLEEP` instruction

bit 2 **Z:** Zero bit
- 1 = The result of an arithmetic or logic operation is zero
- 0 = The result of an arithmetic or logic operation is not zero

bit 1 **DC:** Digit Carry/$\overline{\text{Digit Borrow}}$ bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)(1)
- 1 = A carry-out from the 4th low-order bit of the result occurred
- 0 = No carry-out from the 4th low-order bit of the result

bit 0 **C:** Carry/$\overline{\text{Borrow}}$ bit(1) (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)(1)
- 1 = A carry-out from the Most Significant bit of the result occurred
- 0 = No carry-out from the Most Significant bit of the result occurred

Note 1: For $\overline{\text{Borrow}}$, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand.

6.2.2.1 HFINTOSC

The High-Frequency Internal Oscillator (HFINTOSC) is a factory calibrated 16 MHz internal clock source. The frequency of the HFINTOSC can be altered via software using the OSCTUNE register (Register 6-3).

The output of the HFINTOSC connects to a postscaler and multiplexer (see Figure 6-1). One of multiple frequencies derived from the HFINTOSC can be selected via software using the IRCF<3:0> bits of the OSCCON register. See **Section 6.2.2.7 "Internal Oscillator Clock Switch Timing"** for more information.

The HFINTOSC is enabled by:

- Configure the IRCF<3:0> bits of the OSCCON register for the desired HF frequency, and
- FOSC<2:0> = 100, or
- Set the System Clock Source (SCS) bits of the OSCCON register to '1x'.

A fast startup oscillator allows internal circuits to power up and stabilize before switching to HFINTOSC.

The High Frequency Internal Oscillator Ready bit (HFIOFR) of the OSCSTAT register indicates when the HFINTOSC is running.

The High Frequency Internal Oscillator Status Locked bit (HFIOFL) of the OSCSTAT register indicates when the HFINTOSC is running within 2% of its final value.

The High Frequency Internal Oscillator Stable bit (HFIOFS) of the OSCSTAT register indicates when the HFINTOSC is running within 0.5% of its final value.

6.2.2.2 MFINTOSC

The Medium-Frequency Internal Oscillator (MFINTOSC) is a factory calibrated 500 kHz internal clock source. The frequency of the MFINTOSC can be altered via software using the OSCTUNE register (Register 6-3).

The output of the MFINTOSC connects to a postscaler and multiplexer (see Figure 6-1). One of nine frequencies derived from the MFINTOSC can be selected via software using the IRCF<3:0> bits of the OSCCON register. See **Section 6.2.2.7 "Internal Oscillator Clock Switch Timing"** for more information.

The MFINTOSC is enabled by:

- Configure the IRCF<3:0> bits of the OSCCON register for the desired HF frequency, and
- FOSC<2:0> = 100, or
- Set the System Clock Source (SCS) bits of the OSCCON register to '1x'

The Medium Frequency Internal Oscillator Ready bit (MFIOFR) of the OSCSTAT register indicates when the MFINTOSC is running.

6.2.2.3 Internal Oscillator Frequency Adjustment

The 500 kHz internal oscillator is factory calibrated. This internal oscillator can be adjusted in software by writing to the OSCTUNE register (Register 6-3). Since the HFINTOSC and MFINTOSC clock sources are derived from the 500 kHz internal oscillator a change in the OSCTUNE register value will apply to both.

The default value of the OSCTUNE register is '0'. The value is a 6-bit two's complement number. A value of 1Fh will provide an adjustment to the maximum frequency. A value of 20h will provide an adjustment to the minimum frequency.

When the OSCTUNE register is modified, the oscillator frequency will begin shifting to the new frequency. Code execution continues during this shift. There is no indication that the shift has occurred.

OSCTUNE does not affect the LFINTOSC frequency. Operation of features that depend on the LFINTOSC clock source frequency, such as the Power-up Timer (PWRT), Watchdog Timer (WDT), Fail-Safe Clock Monitor (FSCM) and peripherals, are *not* affected by the change in frequency.

6.2.2.4 LFINTOSC

The Low-Frequency Internal Oscillator (LFINTOSC) is an uncalibrated 31 kHz internal clock source.

The output of the LFINTOSC connects to a multiplexer (see Figure 6-1). Select 31 kHz, via software, using the IRCF<3:0> bits of the OSCCON register. See **Section 6.2.2.7 "Internal Oscillator Clock Switch Timing"** for more information. The LFINTOSC is also the frequency for the Power-up Timer (PWRT), Watchdog Timer (WDT) and Fail-Safe Clock Monitor (FSCM).

The LFINTOSC is enabled by selecting 31 kHz (IRCF<3:0> bits of the OSCCON register = 000) as the system clock source (SCS bits of the OSCCON register = 1x), or when any of the following are enabled:

- Configure the IRCF<3:0> bits of the OSCCON register for the desired LF frequency, and
- FOSC<2:0> = 100, or
- Set the System Clock Source (SCS) bits of the OSCCON register to '1x'

Peripherals that use the LFINTOSC are:

- Power-up Timer (PWRT)
- Watchdog Timer (WDT)
- Fail-Safe Clock Monitor (FSCM)

The Low-Frequency Internal Oscillator Ready bit (LFIOFR) of the OSCSTAT register indicates when the LFINTOSC is running.

6.6 Register Definitions: Oscillator Control

REGISTER 6-1: OSCCON: OSCILLATOR CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-1/1	R/W-1/1	R/W-1/1	U-0	R/W-0/0	R/W-0/0
SPLLEN	IRCF<3:0>				—	SCS<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **SPLLEN:** Software PLL Enable bit
If PLLEN in Configuration Words = 1:
SPLLEN bit is ignored. 4x PLL is always enabled (subject to oscillator requirements)
If PLLEN in Configuration Words = 0:
1 = 4x PLL Is enabled
0 = 4x PLL is disabled

bit 6-3 **IRCF<3:0>:** Internal Oscillator Frequency Select bits
1111 = 16 MHz HF or 32 MHz HF(2)
1110 = 8 MHz or 32 MHz HF(2)
1101 = 4 MHz HF
1100 = 2 MHz HF
1011 = 1 MHz HF
1010 = 500 kHz HF(1)
1001 = 250 kHz HF(1)
1000 = 125 kHz HF(1)
0111 = 500 kHz MF (default upon Reset)
0110 = 250 kHz MF
0101 = 125 kHz MF
0100 = 62.5 kHz MF
0011 = 31.25 kHz HF(1)
0010 = 31.25 kHz MF
000x = 31 kHz LF

bit 2 **Unimplemented:** Read as ‘0’

bit 1-0 **SCS<1:0>:** System Clock Select bits
1x = Internal oscillator block
01 = Timer1 oscillator
00 = Clock determined by FOSC<2:0> in Configuration Words.

Note 1: Duplicate frequency derived from HFINTOSC.
2: 32 MHz when SPLLEN bit is set. Refer to **Section 6.2.2.6 “32 MHz Internal Oscillator Frequency Selection”**.

REGISTER 6-2: OSCSTAT: OSCILLATOR STATUS REGISTER

R-1/q	R-0/q	R-q/q	R-0/q	R-0/q	R-q/q	R-0/0	R-0/q
T1OSCR	PLLR	OSTS	HFIOFR	HFIOFL	MFIOFR	LFIOFR	HFIOFS
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Conditional

bit 7 **T1OSCR:** Timer1 Oscillator Ready bit
If T1OSCEN = 1:
1 = Timer1 oscillator is ready
0 = Timer1 oscillator is not ready
If T1OSCEN = 0:
1 = Timer1 clock source is always ready

bit 6 **PLLR** 4x PLL Ready bit
1 = 4x PLL is ready
0 = 4x PLL is not ready

bit 5 **OSTS:** Oscillator Start-up Timer Status bit
1 = Running from the clock defined by the FOSC<2:0> bits of the Configuration Words
0 = Running from an internal oscillator (FOSC<2:0> = 100)

bit 4 **HFIOFR:** High-Frequency Internal Oscillator Ready bit
1 = HFINTOSC is ready
0 = HFINTOSC is not ready

bit 3 **HFIOFL:** High-Frequency Internal Oscillator Locked bit
1 = HFINTOSC is at least 2% accurate
0 = HFINTOSC is not 2% accurate

bit 2 **MFIOFR:** Medium-Frequency Internal Oscillator Ready bit
1 = MFINTOSC is ready
0 = MFINTOSC is not ready

bit 1 **LFIOFR:** Low-Frequency Internal Oscillator Ready bit
1 = LFINTOSC is ready
0 = LFINTOSC is not ready

bit 0 **HFIOFS:** High-Frequency Internal Oscillator Stable bit
1 = HFINTOSC is at least 0.5% accurate
0 = HFINTOSC is not 0.5% accurate

8.6 Register Definitions: Interrupt Control

REGISTER 8-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R-0/0
GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF(1)
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **GIE:** Global Interrupt Enable bit
1 = Enables all active interrupts
0 = Disables all interrupts

bit 6 **PEIE:** Peripheral Interrupt Enable bit
1 = Enables all active peripheral interrupts
0 = Disables all peripheral interrupts

bit 5 **TMR0IE:** Timer0 Overflow Interrupt Enable bit
1 = Enables the Timer0 interrupt
0 = Disables the Timer0 interrupt

bit 4 **INTE:** INT External Interrupt Enable bit
1 = Enables the INT external interrupt
0 = Disables the INT external interrupt

bit 3 **IOCIE:** Interrupt-on-Change Enable bit
1 = Enables the interrupt-on-change
0 = Disables the interrupt-on-change

bit 2 **TMR0IF:** Timer0 Overflow Interrupt Flag bit
1 = TMR0 register has overflowed
0 = TMR0 register did not overflow

bit 1 **INTF:** INT External Interrupt Flag bit
1 = The INT external interrupt occurred
0 = The INT external interrupt did not occur

bit 0 **IOCIF:** Interrupt-on-Change Interrupt Flag bit(1)
1 = When at least one of the interrupt-on-change pins changed state
0 = None of the interrupt-on-change pins have changed state

Note 1: The IOCIF Flag bit is read-only and cleared when all the Interrupt-on-change flags in the IOCBF register have been cleared by software.

Note:	Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

EXAMPLE 12-5: WRITING TO FLASH PROGRAM MEMORY

```
; This write routine assumes the following:
; 1. The 16 bytes of data are loaded, starting at the address in DATA_ADDR
; 2. Each word of data to be written is made up of two adjacent bytes in DATA_ADDR,
;    stored in little endian format
; 3. A valid starting address (the least significant bits = 0000) is loaded in ADDRH:ADDRL
; 4. ADDRH and ADDRL are located in shared data memory 0x70 - 0x7F (common RAM)
;
        BCF         INTCON,GIE     ; Disable ints so required sequences will execute properly
        BANKSEL     EEADRH         ; Bank 3
        MOVF        ADDRH,W        ; Load initial address
        MOVWF       EEADRH         ;
        MOVF        ADDRL,W        ;
        MOVWF       EEADRL         ;
        MOVLW       LOW DATA_ADDR  ; Load initial data address
        MOVWF       FSR0L          ;
        MOVLW       HIGH DATA_ADDR ; Load initial data address
        MOVWF       FSR0H          ;
        BSF         EECON1,EEPGD   ; Point to program memory
        BCF         EECON1,CFGS    ; Not configuration space
        BSF         EECON1,WREN    ; Enable writes
        BSF         EECON1,LWLO    ; Only Load Write Latches
LOOP
        MOVIW       FSR0++         ; Load first data byte into lower
        MOVWF       EEDATL         ;
        MOVIW       FSR0++         ; Load second data byte into upper
        MOVWF       EEDATH         ;

        MOVF        EEADRL,W       ; Check if lower bits of address are '000'
        XORLW       0x0F           ; Check if we're on the last of 16 addresses
        ANDLW       0x0F           ;
        BTFSC       STATUS,Z       ; Exit if last of 16 words,
        GOTO        START_WRITE    ;

  Required Sequence
        MOVLW       55h            ; Start of required write sequence:
        MOVWF       EECON2         ; Write 55h
        MOVLW       0AAh           ;
        MOVWF       EECON2         ; Write AAh
        BSF         EECON1,WR      ; Set WR bit to begin write
        NOP                        ; Any instructions here are ignored as processor
                                   ; halts to begin write sequence
        NOP                        ; Processor will stop here and wait for write to complete.

                                   ; After write processor continues with 3rd instruction.

        INCF        EEADRL,F       ; Still loading latches Increment address
        GOTO        LOOP           ; Write next latches

START_WRITE
        BCF         EECON1,LWLO    ; No more loading latches - Actually start Flash program
                                   ; memory write

  Required Sequence
        MOVLW       55h            ; Start of required write sequence:
        MOVWF       EECON2         ; Write 55h
        MOVLW       0AAh           ;
        MOVWF       EECON2         ; Write AAh
        BSF         EECON1,WR      ; Set WR bit to begin write
        NOP                        ; Any instructions here are ignored as processor
                                   ; halts to begin write sequence
        NOP                        ; Processor will stop here and wait for write complete.

                                   ; after write processor continues with 3rd instruction
        BCF         EECON1,WREN    ; Disable writes
        BSF         INTCON,GIE     ; Enable interrupts
```

13.2 Register Definitions: Alternate Pin Function Control

REGISTER 13-1: APFCON1: ALTERNATE PIN FUNCTION CONTROL 1 REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
C2OUTSEL	CCP1SEL	SDOSEL	SCKSEL	SDISEL	TXSEL	RXSEL	CCP2SEL
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **C2OUTSEL**: C2OUT Pin Selection bit
1 = C2OUT is on pin RA6
0 = C2OUT is on pin RA5

bit 6 **CCP1SEL**: CCP1 Input/Output Pin Selection bit
1 = CCP1 is on pin RB0
0 = CCP1 is on pin RC2

bit 5 **SDOSEL**: MSSP SDO Pin Selection bit
1 = SDO is on pin RB5
0 = SDO is on pin RC5

bit 4 **SCKSEL**: MSSP Serial Clock (SCL/SCK) Pin Selection bit
1 = SCL/SCK is on pin RB7
0 = SCL/SCK is on pin RC3

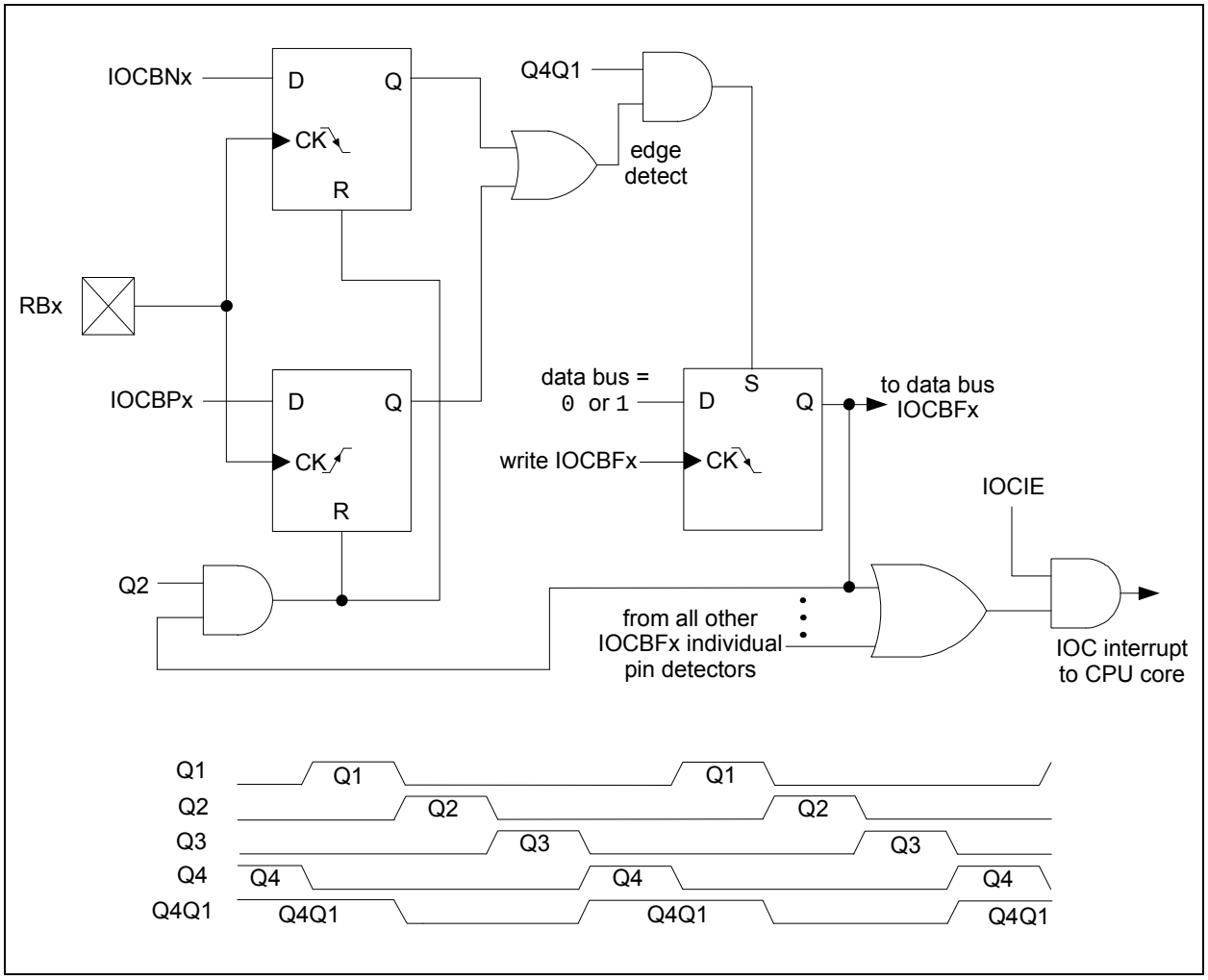
bit 3 **SDISEL**: MSSP Serial Data (SDA/SDI) Output Pin Selection bit
1 = SDA/SDI is on pin RB6
0 = SDA/SDI is on pin RC4

bit 2 **TXSEL**: TX Pin Selection bit
1 = TX is on pin RB6
0 = TX is on pin RC6

bit 1 **RXSEL**: RX Pin Selection bit
1 = RX is on pin RB7
0 = RX is on pin RC7

bit 0 **CCP2SEL**: CCP2 Input/Output Pin Selection bit
1 = CCP2 is on pin RB3
0 = CCP2 is on pin RC1

FIGURE 14-1: INTERRUPT-ON-CHANGE BLOCK DIAGRAM



17.1 ADC Configuration

When configuring and using the ADC the following functions must be considered:

- Port configuration
- Channel selection
  - Single-ended
  - Differential
- ADC voltage reference selection
- ADC conversion clock source
- Interrupt control
- Result formatting

17.1.1 PORT CONFIGURATION

The ADC can be used to convert both analog and digital signals. When converting analog signals, the I/O pin should be configured for analog by setting the associated TRIS and ANSEL bits. Refer to **Section 13.0 "I/O Ports"** for more information.

Note:	Analog voltages on any pin that is defined as a digital input may cause the input buffer to conduct excess current.

17.1.2 CHANNEL SELECTION

There are up to 18 channel selections available:

- AN<13:8, 4:0> pins (PIC16(L)F1788 only)
- AN<21, 13:0> pins (PIC16(L)F1789 only)
- Temperature Indicator
- DAC_output
- FVR (Fixed Voltage Reference) Output

Refer to **Section 15.0 "Fixed Voltage Reference (FVR)"** and **Section 16.0 "Temperature Indicator Module"** for more information on these channel selections.

When converting differential signals, the negative input for the channel is selected with the CHSN<3:0> bits of the ADCON2 register. Any positive input can be paired with any negative input to determine the differential channel.

The CHS<4:0> bits of the ADCON0 register determine which positive channel is selected.

When CHSN<3:0> = 1111 then the ADC is effectively a single ended ADC converter.

When changing channels, a delay is required before starting the next conversion.

17.1.3 ADC VOLTAGE REFERENCE

The ADPREF bits of the ADCON1 register provide control of the positive voltage reference. The positive voltage reference can be:

- V_{REF+}
- V_{DD}
- FVR Buffer1

The ADNREF bits of the ADCON1 register provide control of the negative voltage reference. The negative voltage reference can be:

- V_{REF-} pin
- V_{SS}

See **Section 15.0 "Fixed Voltage Reference (FVR)"** for more details on the Fixed Voltage Reference.

17.1.4 CONVERSION CLOCK

The source of the conversion clock is software selectable via the ADCS bits of the ADCON1 register. There are seven possible clock options:

- $F_{OSC}/2$
- $F_{OSC}/4$
- $F_{OSC}/8$
- $F_{OSC}/16$
- $F_{OSC}/32$
- $F_{OSC}/64$
- F_{RC} (dedicated internal F_{RC} oscillator)

The time to complete one bit conversion is defined as T_{AD}. One full 12-bit conversion requires 15 T_{AD} periods as shown in Figure 17-2.

For correct conversion, the appropriate T_{AD} specification must be met. Refer to the ADC conversion requirements in **Section 31.0 "Electrical Specifications"** for more information. Table 17-1 gives examples of appropriate ADC clock selections.

Note:	Unless using the F_{RC}, any changes in the system clock frequency will change the ADC clock frequency, which may adversely affect the ADC result.

23.11 Register Definitions: Timer1 Control

T

REGISTER 23-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	U-0	R/W-0/u
TMR1CS<1:0>		T1CKPS<1:0>		T1OSCEN	$\overline{\text{T1SYNC}}$	—	TMR1ON
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **TMR1CS<1:0>:** Timer1 Clock Source Select bits

11 = Reserved, do not use.
10 = Timer1 clock source is pin or oscillator:
If T1OSCEN = 0:
External clock from T1CKI pin (on the rising edge)
If T1OSCEN = 1:
Crystal oscillator on T1OSI/T1OSO pins
01 = Timer1 clock source is system clock (FOSC)
00 = Timer1 clock source is instruction clock (FOSC/4)

bit 5-4 **T1CKPS<1:0>:** Timer1 Input Clock Prescale Select bits

11 = 1:8 Prescale value
10 = 1:4 Prescale value
01 = 1:2 Prescale value
00 = 1:1 Prescale value

bit 3 **T1OSCEN:** LP Oscillator Enable Control bit

1 = Dedicated Timer1 oscillator circuit enabled
0 = Dedicated Timer1 oscillator circuit disabled

bit 2 **$\overline{\text{T1SYNC}}$:** Timer1 Synchronization Control bit

1 = Do not synchronize asynchronous clock input
0 = Synchronize asynchronous clock input with system clock (FOSC)

bit 1 **Unimplemented:** Read as ‘0’

bit 0 **TMR1ON:** Timer1 On bit

1 = Enables Timer1
0 = Stops Timer1 and clears Timer1 gate flip-flop

26.2.6 CLOCK PRESCALER

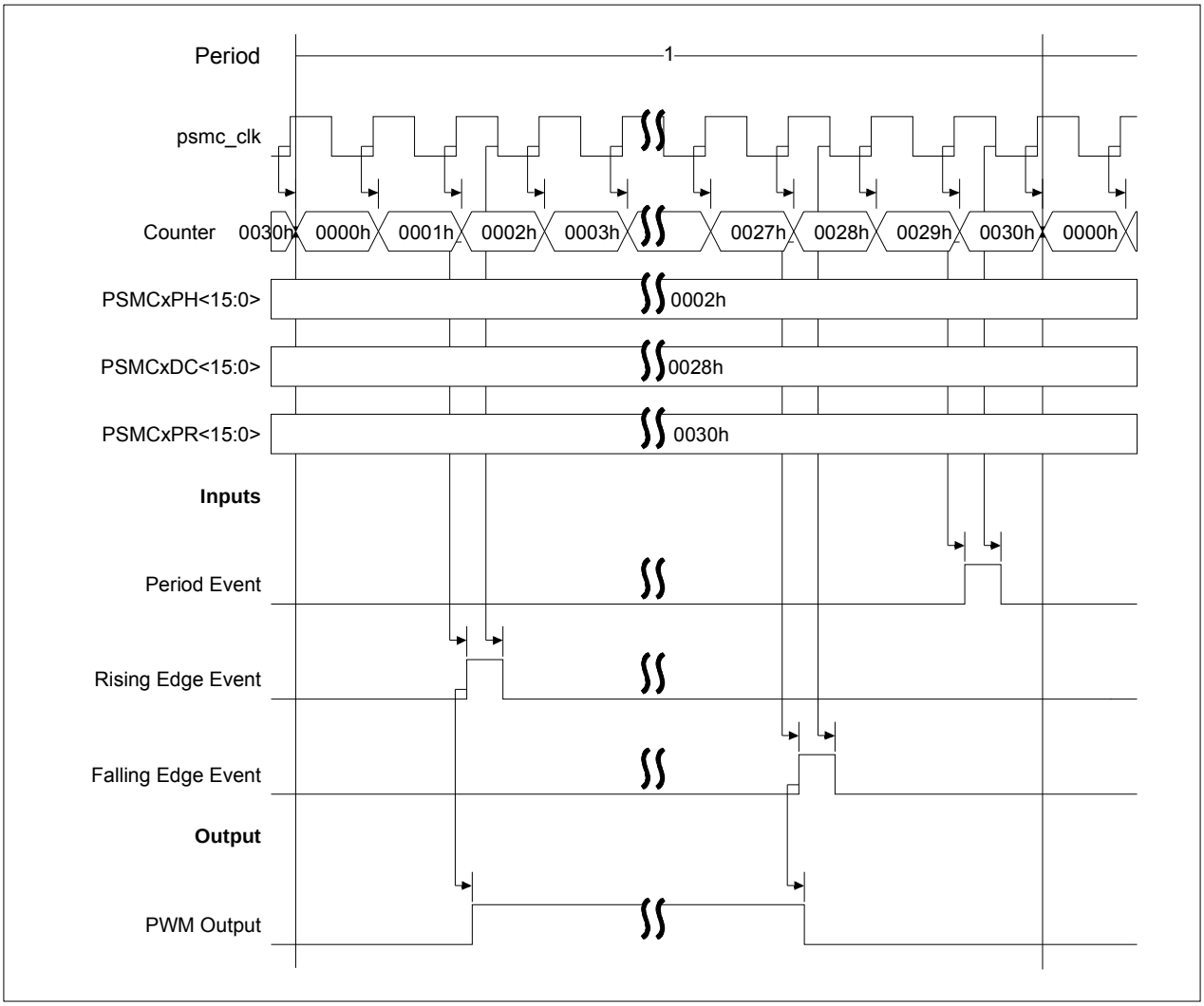
There are four prescaler choices available to be applied to the selected clock:

- Divide by 1
- Divide by 2
- Divide by 4
- Divide by 8

The clock source is selected with the PxCPRE<1:0> bits of the PSMCx Clock Control (PSMCxCLK) register (Register 26-7).

The prescaler output is psmc_clk, which is the clock used by all of the other portions of the PSMC module.

FIGURE 26-3: TIME BASE WAVEFORM GENERATION



26.3.4 PUSH-PULL PWM WITH COMPLEMENTARY OUTPUTS

The complementary push-pull PWM is used to drive transistor bridge circuits as well as synchronous switches on the secondary side of the bridge. The PWM waveform is output on four pins presented as two pairs of two-output signals with a normal and complementary output in each pair. Dead band can be inserted between the normal and complementary outputs at the transition times.

26.3.4.1 Mode Features

- Dead-band control is available
- No steering control available
- Primary PWM output is only on:
  - PSMCxA
  - PSMCxB
- Complementary PWM output is only on:
  - PSMCxE
  - PSMCxF

Note: This is a subset of the 6-pin output of the push-pull PWM output, which is why pin functions are fixed in these positions, so they are compatible with that mode. See **Section 26.3.6 "Push-Pull PWM with Four Full-Bridge and Complementary Outputs"**.

26.3.4.2 Waveform Generation

Push-Pull waveforms generate alternating outputs on the output pairs. Therefore, there are two sets of rising edge events and two sets of falling edge events

Odd numbered period rising edge event:

- PSMCxE is set inactive
- Dead-band rising is activated (if enabled)
- PSMCxA is set active

Odd numbered period falling edge odd event:

- PSMCxA is set inactive
- Dead-band falling is activated (if enabled)
- PSMCxE is set active

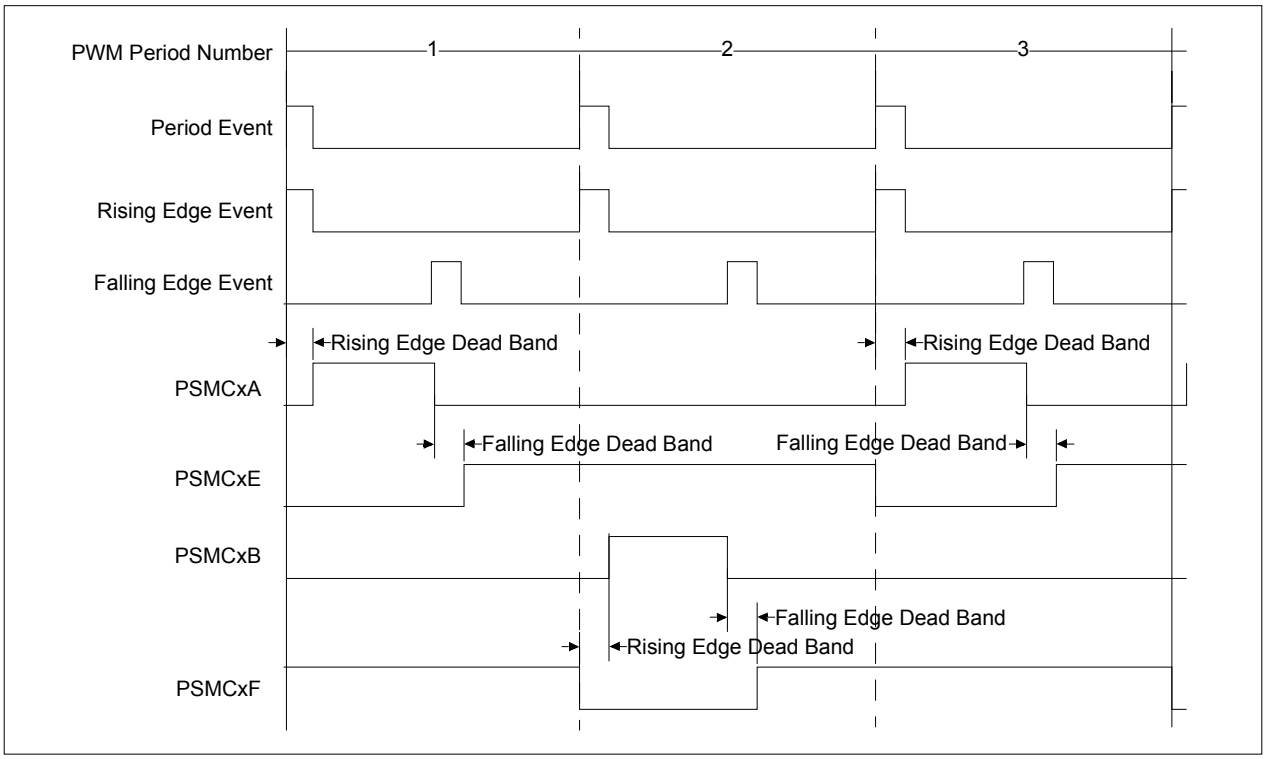
Even numbered period rising edge event:

- PSMCxF is set inactive
- Dead-band rising is activated (if enabled)
- PSMCxB is set active

Even numbered period falling edge event:

- PSMCxB is set inactive
- Dead-band falling is activated (if enabled)
- PSMCxF is set active

FIGURE 26-7: PUSH-PULL WITH COMPLEMENTARY OUTPUTS PWM WAVEFORM



REGISTER 26-27: PSMCxDBR: PSMC RISING EDGE DEAD-BAND TIME REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
PSMCxDBR<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **PSMCxDBR<7:0>:** Rising Edge Dead-Band Time bits
= Unsigned number of PSMCx psmc_clk clock periods in rising edge dead band

REGISTER 26-28: PSMCxDBF: PSMC FALLING EDGE DEAD-BAND TIME REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
PSMCxDBF<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **PSMCxDBF<7:0>:** Falling Edge Dead-Band Time bits
= Unsigned number of PSMCx psmc_clk clock periods in falling edge dead band

REGISTER 26-29: PSMCxFFA: PSMC FRACTIONAL FREQUENCY ADJUST REGISTER

U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—	PSMCxFFA<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-4 **Unimplemented:** Read as ‘0’

bit 3-0 **PSMCxFFA<3:0>:** Fractional Frequency Adjustment bits
= Unsigned number of fractional PSMCx psmc_clk clock periods to add to each period event time. The fractional time period = 1/(16*psmc_clk)

TABLE 31-4: I/O PORTS (CONTINUED)

Standard Operating Conditions (unless otherwise stated)							
Param No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
		Capacitive Loading Specs on Output Pins					
D101*	COSC2	OSC2 pin	—	—	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1
D101A*	CIO	All I/O pins	—	—	50	pF	
		VCAP Capacitor Charging					
D102		Charging current	—	200	—	μA	
D102A		Source/sink capability when charging complete	—	0.0	—	mA	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended to use an external clock in RC mode.

2: Negative current is defined as current sourced by the pin.

3: The leakage current on the $\overline{MCLR}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

4: Including OSC2 in CLKOUT mode.

FIGURE 31-5: CLOCK TIMING

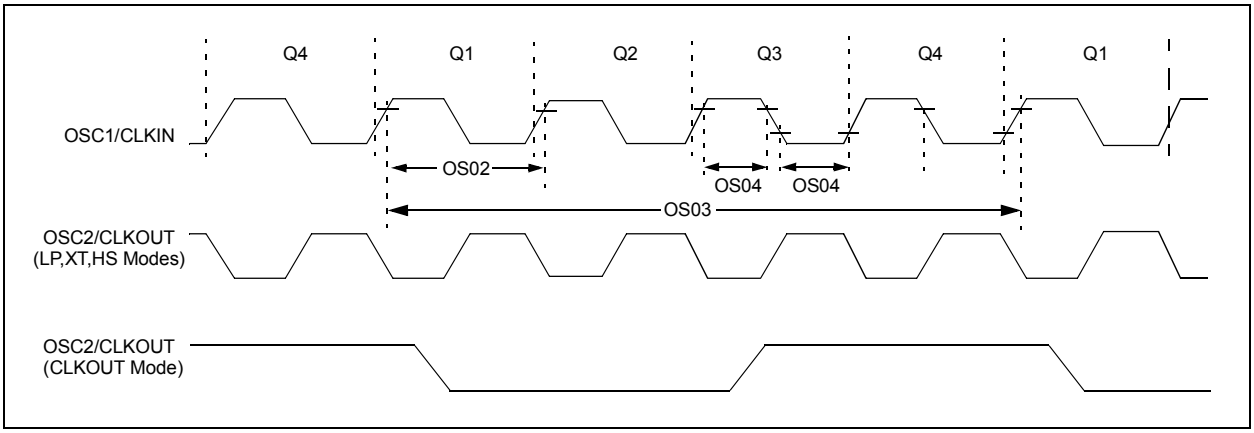


TABLE 31-6: CLOCK OSCILLATOR TIMING REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)							
Param No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
OS01	FOSC	External CLKIN Frequency(1)	DC	—	0.5	MHz	EC Oscillator mode (low)
			DC	—	4	MHz	EC Oscillator mode (medium)
			DC	—	20	MHz	EC Oscillator mode (high)
		Oscillator Frequency(1)	—	32.768	—	kHz	LP Oscillator mode
			0.1	—	4	MHz	XT Oscillator mode
			1	—	4	MHz	HS Oscillator mode
			1	—	20	MHz	HS Oscillator mode, VDD > 2.7V
			DC	—	4	MHz	RC Oscillator mode, VDD > 2.0V
OS02	TOSC	External CLKIN Period(1)	27	—	∞	μs	LP Oscillator mode
			250	—	∞	ns	XT Oscillator mode
			50	—	∞	ns	HS Oscillator mode
			50	—	∞	ns	EC Oscillator mode
		Oscillator Period(1)	—	30.5	—	μs	LP Oscillator mode
			250	—	10,000	ns	XT Oscillator mode
			50	—	1,000	ns	HS Oscillator mode
			250	—	—	ns	RC Oscillator mode
OS03	TCY	Instruction Cycle Time(1)	200	TCY	DC	ns	TCY = 4/FOSC
OS04*	TosH, TosL	External CLKIN High, External CLKIN Low	2	—	—	μs	LP oscillator
			100	—	—	ns	XT oscillator
			20	—	—	ns	HS oscillator
OS05*	TosR, TosF	External CLKIN Rise, External CLKIN Fall	0	—	∞	ns	LP oscillator
			0	—	∞	ns	XT oscillator
			0	—	∞	ns	HS oscillator

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min" values with an external clock applied to OSC1 pin. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

Note: Unless otherwise noted, V_{IN} = 5V, F_{OSC} = 300 kHz, C_{IN} = 0.1 µF, T_A = 25°C.

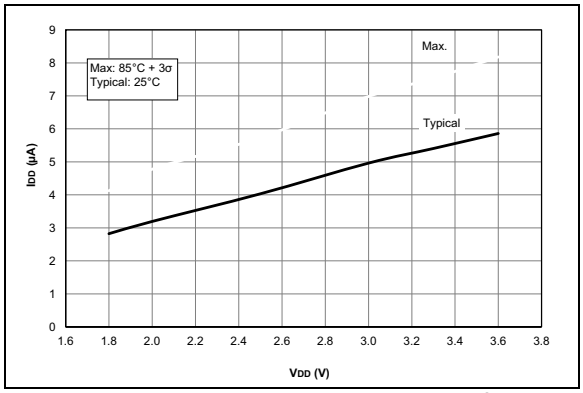


FIGURE 32-19: *IDD, LFINTOSC Mode, Fosc = 31 kHz, PIC16LF1788/9 Only.*

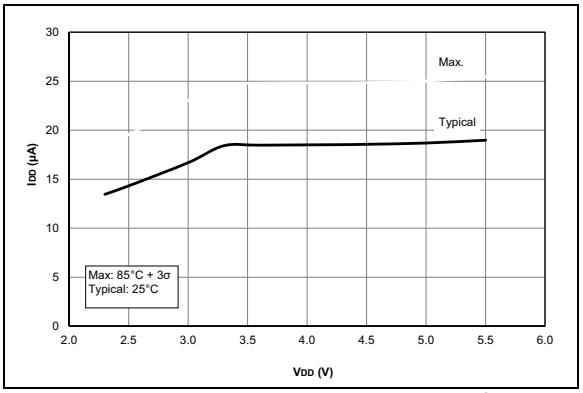


FIGURE 32-20: *IDD, LFINTOSC Mode, Fosc = 31 kHz, PIC16F1788/9 Only.*

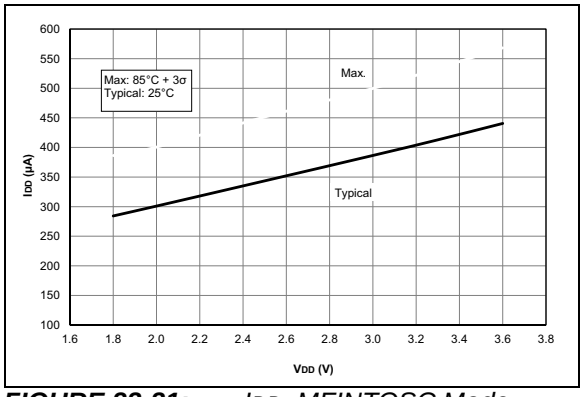


FIGURE 32-21: *IDD, MFINTOSC Mode, Fosc = 500 kHz, PIC16LF1788/9 Only.*

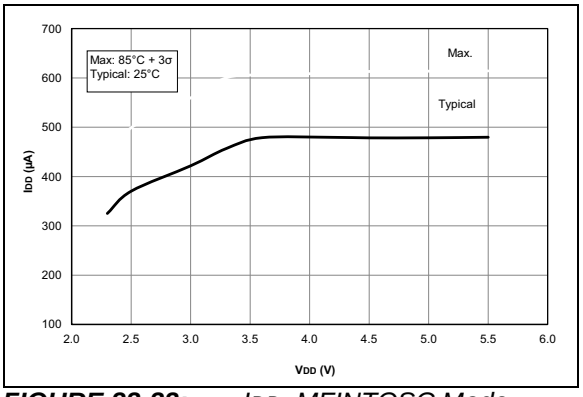


FIGURE 32-22: *IDD, MFINTOSC Mode, Fosc = 500 kHz, PIC16F1788/9 Only.*

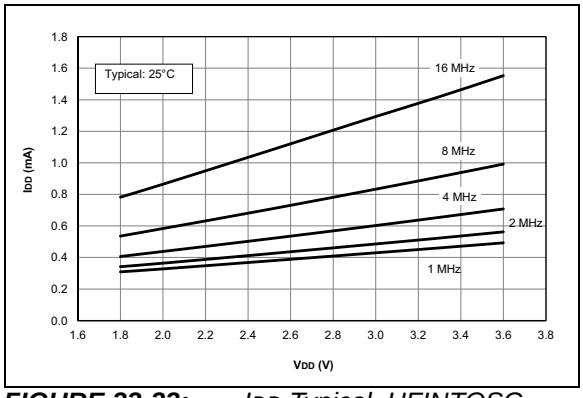


FIGURE 32-23: *IDD Typical, HFINTOSC Mode, PIC16LF1788/9 Only.*

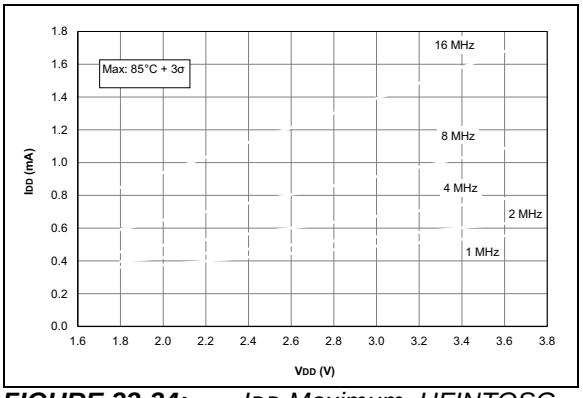
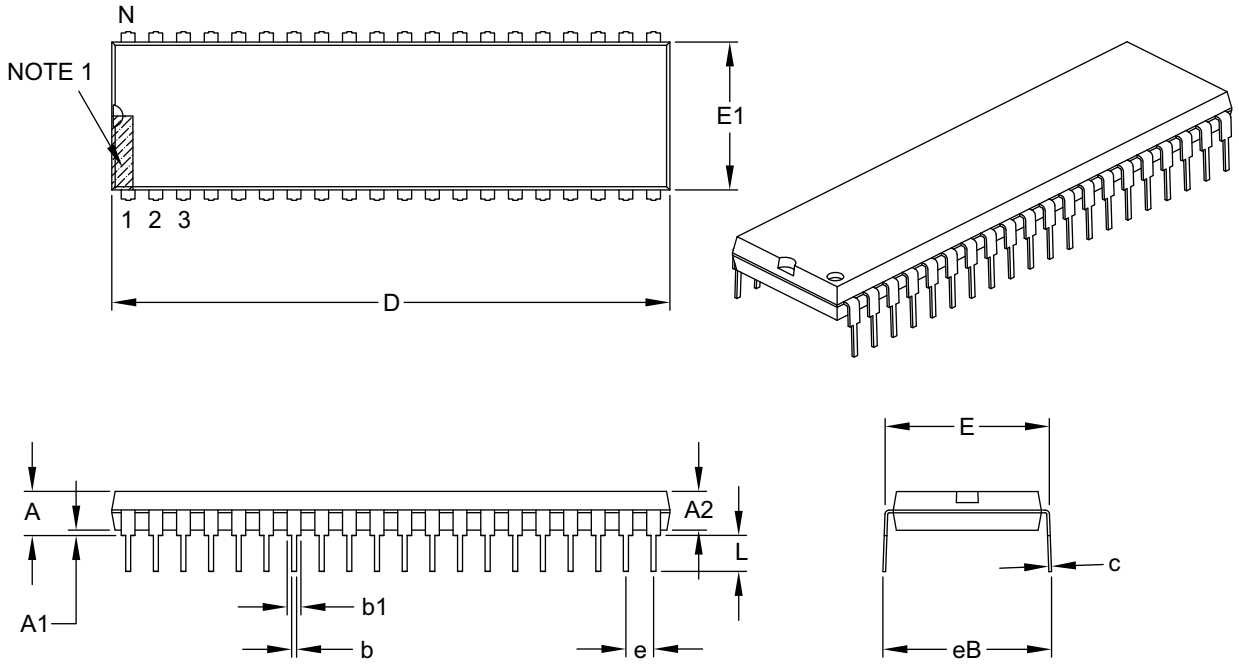


FIGURE 32-24: *IDD Maximum, HFINTOSC Mode, PIC16LF1788/9 Only.*

40-Lead Plastic Dual In-Line (P) – 600 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		40	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.250
Molded Package Thickness	A2	.125	–	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.590	–	.625
Molded Package Width	E1	.485	–	.580
Overall Length	D	1.980	–	2.095
Tip to Seating Plane	L	.115	–	.200
Lead Thickness	c	.008	–	.015
Upper Lead Width	b1	.030	–	.070
Lower Lead Width	b	.014	–	.023
Overall Row Spacing §	eB	–	–	.700

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-016B